

Piezoelectric Lateral-Extensional Mode Resonators with Reconfigurable Electrode and Resonance Mode-Switching Behavior Enabled by a VO₂ Thin-Film

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Abstract— This paper presents the first two-port lateral-extensional mode zinc oxide (ZnO) piezoelectric resonator with a reconfigurable bottom electrode that is enabled by embedding a vanadium dioxide (VO₂) thin film. The insulator-to-metal phase transition of VO₂ is triggered by substrate heating that translates to abrupt changes of electric field patterns and piezoelectrically transduced modal vibrations, thus allowing mode-switching of piezoelectric resonators at specific frequencies. Finite element method (FEM) analysis was employed to model the broadband frequency response, while frequency characteristics of the corresponding two-port resonator were measured over a temperature range between 20°C and 95°C with a specific focus on two resonances at 88 and 148 MHz. By leveraging the hysteretic behavior of VO₂ thin film during a heating/cooling cycle, a change of both the capacitive feedthrough and resonance signal levels were observed, due to the abrupt change in the conductivity of VO₂ during its phase transition. The unique switch-on behavior of the resonance at 88 MHz starts at 70°C during the heating cycle, while the switch-off transition begins at 60°C during the cooling cycle. On the other hand, when the temperature is increased from 20°C to 60°C, a decrease of the insertion loss and resonance frequency of 12 dB and 0.28 MHz, respectively, were observed for the resonance at 148 MHz. Meanwhile, a resonance frequency increase of 0.42 MHz was observed during a temperature increase from 60°C to 95°C, which can be ascribed to the VO₂ phase transition from monoclinic to rutile phase. The hysteresis loops for insertion loss and resonance frequency indicate a different critical temperature for the phase transition from the monoclinic (insulator) phase and rutile (metallic) phase and vice versa. The substantial variation of the temperature coefficient of frequency can be largely ascribed to electrode reconfiguration enabled by VO₂ phase transition.

Index Terms—microelectromechanical systems (MEMS), lateral extensional mode, piezoelectric thin film transducers, phase transition material, tunable resonators

I. INTRODUCTION

Microelectromechanical system (MEMS) resonators have been widely investigated as timing and frequency control devices and sub-systems of radio frequency (RF) front ends, such as, filters, mixers, oscillators, frequency synthesizers in wireless communication systems [1]. The RF MEMS resonator technologies can be divided into two main categories, which are capacitively transduced resonators [2][3] and piezoelectrically transduced resonators. Piezoelectric resonators are typically composed of a piezoelectric thin film that is sandwiched in between patterned top and bottom electrodes that are designed to excite the desired resonance mode through matching the electric field with the strain field of the desired mode shape [4]. The common piezoelectric materials employed by piezoelectric resonators are aluminum nitride (AlN) [5]–[7], lithium niobate (LiNbO₃) [8]–[10], zinc oxide (ZnO) [11]–[13], [14] and lead zirconate titanate (PZT) [14]–[16]. The electric field generated by the top and bottom electrode across the piezoelectric transducer layer creates an in-plane lateral strain distribution, which excites the resonator body into modal vibration of the corresponding mode shape and resonance frequency. There are different types of vibration modes in MEMS resonators, such as, flexural mode, shear mode, and extensional mode. There are a few extensional mode types, including length-extensional mode, width-extensional mode, thickness mode, and lateral extensional modes [17]. AlN and ZnO are widely investigated piezoelectric materials that are employed along with interdigitated (IDT) electrodes for lateral extensional mode resonators [13], [16], [18]–[20], where the resonance frequency

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is proportional to the pitch size of the top IDT electrodes or another characteristic dimension defined by high-resolution lithography. There are many prior works on IDT resonators to cover topics such as anchor losses [21][22], electrode material [23][24], and electrode design [20][25][26]. Recently, the bottom electrode design has also been explored [20][27]–[29] for the purpose of enhancing performance metrics such as quality factor (Q), electromechanical coupling (k_t^2) and figure of merit (FOM) as well as capacitive feedthrough reduction.

In recent years, significant efforts have been committed to implement high performance piezoelectric MEMS resonators, including devices that have been designed to cope with high demand of reconfigurable functionalities, while mitigating energy dissipations and retaining high quality factor. For instance, advancements have been made by incorporating chalcogenide phase-change materials (e.g., germanium telluride (GeTe)) into MEMS resonators [30][31]. Its phase transition at approximately 430 °C comes with drastic changes in terms of its resistance (on the order of 10^6) between the OFF amorphous phase and ON crystalline phase. As a consequence, the ability to cycle between the ON/OFF state over large durations [32], low insertion loss values [3], and resonance frequencies of 3.6 GHz [33] have been reported. Meanwhile, other alternative phase-transition materials, such as vanadium dioxide (VO_2), have also been studied that have demonstrated repeatable behavior with reconfigurable and programmable memory states that could be incorporated into a new design of piezoelectric resonators to offer ease of fabrication, low power consumption, and lower transition temperatures.

Vanadium dioxide (VO_2) is a phase-change material that exhibits several crystalline phases. At room temperature, VO_2 presents itself with a low-temperature monoclinic phase, which transforms reversely to a high-temperature rutile-type structure near 68°C [34]. The insulator-to-metal transition (IMT) of the phase-change material is accompanied by changes in the mechanical [35][36], optical [37][38], and electrical [39] properties. Hysteretic behavior is also anticipated during the phase transition, which has been exploited to demonstrate high-performance MEMS devices with programmable capabilities [38][40]. In the field of MEMS resonators, a thin film VO_2 has been deposited on top of the device as a part of the resonator body. During the heating cycle and as a consequence of the IMT, stresses are induced to the resonator body that results in a resonance frequency shift. This shows the potential of the VO_2 to offer unique reconfigurability for developing tunable band pass filters or other frequency control and timing functions [41].

In an effort to further contribute solutions in achieving high reliability and reconfigurability, we demonstrate, for the first time, the incorporation of VO_2 phase-change material within two-port ZnO piezoelectric lateral-extensional mode resonators with reconfigurable bottom electrodes. The effects of the IMT of VO_2 on the electric field patterns between the electrodes are studied. An equivalent circuit model is adopted to offer a clear indication on how the addition of VO_2 significantly affects the parasitic capacitance of the device based on equivalent circuit model (e.g., mBVD model), thus translating to a substantial signal response change at the targeted resonance frequencies. In addition, a finite element method (FEM) study is presented that closely agrees with the experimental results and aids in the

identification of the specific resonance modes of the resonator.

II. RECONFIGURABLE BOTTOM ELECTRODE DESIGN

A $320\mu\text{m} \times 80\mu\text{m}$ thin-film ZnO piezoelectric rectangular-plate lateral-extensional mode resonator with a reconfigurable bottom electrode, which can transform between slot-divided and solid rectangular plate, have been strategically designed and implemented by exploiting the temperature-induced phase transition of a VO_2 film. There is one center-located and side-supporting anchor attached on each width side to suspend the resonator plate. The width of each the top electrode IDT finger is $12\mu\text{m}$ and the gap between two adjacent IDT fingers is $5\mu\text{m}$. The width of slot-divided bottom electrode is $5\mu\text{m}$, which are aligned with the gaps of the two-port top IDT electrodes. The thickness of each layer is detailed in the fabrication section.

Fig. 1 presents the schematic-view diagram of two ZnO piezoelectric resonators, one with a rectangular-plate bottom electrode with slot-divided fingers (Fig. 1 (a)) and another design with a solid rectangular shaped bottom electrode (Fig. 1 (b)). As shown in Fig. 1(a), the reconfigurable bottom electrode design strategy in this work is original and innovative, which consists of a slot-divided Pt bottom electrode stacked on top of a VO_2 film as a phase-change material. Meanwhile, the slot-divided Pt bottom electrode is intentionally positioned and aligned within the gaps of the two-port IDT top electrodes to create a unique mode-switching behavior as shown in Fig. 1.

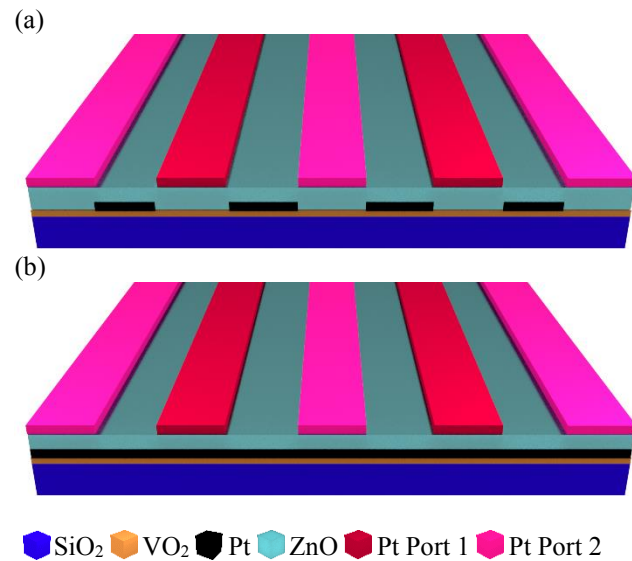


Fig. 1. Schematic-view diagrams of ZnO piezoelectric lateral extensional mode resonators with embedded VO_2 phase-transition thin film underneath a Pt electrode: (a) Design with a reconfigurable electrode composed of slot-divided Pt electrode; and (b) Design with a solid Pt electrode.

As shown in Fig. 2, a rectangular-shaped bottom electrode with slot-divided fingers sandwiched between layers of ZnO piezoelectric transducer and phase-transitionable VO_2 have been adopted to investigate the patterns of the electric fields generated between the IDT top and reconfigurable bottom electrodes on the modal vibration and piezoelectrically-transduced frequency characteristics. In order to strengthen the

changes of the electric field patterns and modal vibrations, the bottom electrode fingers are strategically designed to be aligned with the gaps of the two-port interdigitated top electrodes without any overlap as shown in Fig. 1 (a). Thus, the electric field and piezoelectric response changes that are induced by the phase transition of the VO₂ thin film is maximized. For the pulsed laser deposited (PLD) VO₂ film, the monoclinic (insulator) phase to rutile (metallic) phase transition occurs as temperature rises to roughly 68°C. Below 68°C, thin-film VO₂ is under monoclinic phase to act as an insulation layer underneath slot-divided Pt bottom electrode. As the temperature rises above 68°C, the thin-film VO₂ transitions into rutile phase to behave as a conductive layer to completely fill the divided slots and form a solid rectangular plate, thus reconfiguring the bottom electrode geometry. To the best of our knowledge, VO₂ phase-transition material enabled electrode reconfiguration and resonator mode-switching behavior has never been reported before, and this represents a new strategy to reconfigure acoustic resonators after fabrication. Moreover, intriguing hysteresis of resonance responses over temperature range of the VO₂ phase transition has been observed for the first time, which calls for detailed analysis and further experimental study to reveal device physics among key contribution factors.

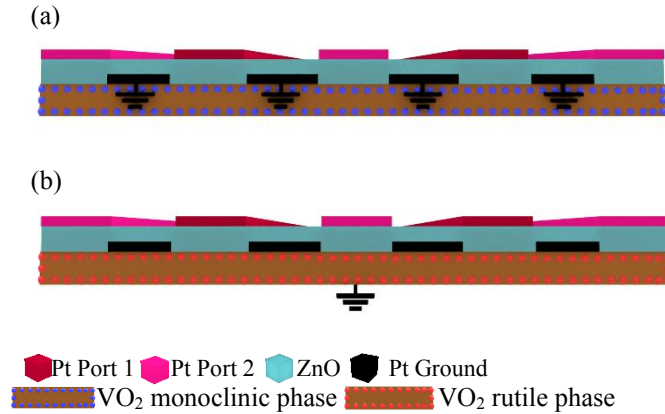


Fig. 2. Cross-section view of the two-port ZnO piezoelectric lateral extensional mode resonators with a thin-film VO₂ phase-transition material enabled reconfigurable bottom electrode, including both operation modes where (a) thin-film VO₂ is in the monoclinic (insulator) phase; (b) thin-film VO₂ in the rutile (metallic) phase

The device in this work is designed to operate in symmetrical width lateral-extensional modes. The resonance frequency of a n^{th} order symmetrical width lateral-extensional mode resonator can be defined as (1):

$$f = \frac{n}{2W} \sqrt{\frac{E}{\rho}} \quad (1)$$

Where n is the order of mode, W is width of the resonator, E is Young's modulus, and ρ is density. The two-port top electrodes of the resonator in this work have a total of 5 IDT fingers, as shown in Fig. 2, which is designed for 5th order ($n=5$) width lateral-extensional mode. The resonance mode at 86 MHz is the

3rd order ($n=3$) lateral-extensional mode that is also detected by 5 IDT-finger top electrodes despite the slightly imperfect match between the modal strain field and the top electrode pattern.

The lower resonance frequency is the 3rd order symmetrical width lateral-extensional mode, which is 86 MHz and 88 MHz based on FEM simulated and measured responses, respectively. This 3rd order symmetrical width lateral-extensional mode only appears, when the VO₂ film is in its rutile (metallic) phase. The other resonance frequency is for the 5th order symmetrical width lateral-extensional mode that is 152 MHz and 148 MHz based on FEM-simulated and measured responses, respectively. This 5th order symmetrical width lateral-extensional mode appears when the VO₂ film is in either monoclinic (insulator) or rutile (metallic) phase. The slight discrepancy in resonance frequency from FEM simulation and measurement can be attributed to the difference in material properties, resonator's lateral dimensions (fabrication tolerance) and layer thicknesses used for simulation as compared to those of microfabricated and measured device.

III. FINITE ELEMENT ANALYSIS OF PIEZOELECTRICALLY-TRANSDUCED LATERAL EXTENSIONAL MODE RESONATORS EQUIPPED WITH A RECONFIGURABLE BOTTOM ELECTRODE

Finite element method (FEM) simulations have been used to model electrical and acoustic responses of the two-port ZnO piezoelectrically-transduced resonator with an embedded thin-film VO₂ phase-transition film that is underneath the ZnO piezoelectric transducer layer and slot-divided rectangular Pt bottom electrode. Fig. 3 presents the simulated broadband frequency characteristics using a three-dimensional (3D) FEM model of a two-port 320μm × 80μm rectangular-plate ZnO piezoelectric resonator equipped with a reconfigurable bottom electrode that can change back and forth between slotted and solid rectangular shape as shown in Fig. 2. The thin-film VO₂ can reversibly transform between its monoclinic (insulator) and rutile (metallic) phases with orders of magnitude change in conductivity. By transitioning into rutile phase when the temperature rises above 68°C, the conductive VO₂ layer completely fills and interconnects the divided slots of the Pt electrode to form a solid rectangular-shaped bottom electrode. Hence, the electric field distributions created between the two top IDT electrodes and reconfigurable bottom electrode vary drastically at the corresponding modal frequencies to result in unrepresented mode switching behavior, which is a new design strategy that has never been reported.

Fig. 3 shows simulated frequency characteristics of the two lateral extensional mode resonances at frequencies of 86 MHz for 3rd order symmetrical width lateral-extensional mode and 152MHz for 5th order width symmetrical lateral-extensional mode, which are concurrently investigated in this work. There is a mode-switching behavior for the lateral extensional mode resonance at 86 MHz due to geometrical change of the bottom electrode between slot-divided and solid plate induced by the VO₂ film conductivity change during its phase transition. When the thin-film VO₂ is under its monoclinic (insulator) phase to retain the bottom electrode in its originally designed slot-divided rectangular shape (Fig. 2(a)), there is no resonance signal due to the lack of vertical electric field that can create an in-plane lateral modal vibration via transverse d₃₁ piezoelectric

coefficient to match the desired strain field needed for the targeted modal vibrations at 86 MHz. Meanwhile, when the thin-film VO₂ is under its rutile (metallic) phase (Fig 2(b)), the bottom electrode is composed of the slot-divided Pt electrode and conductive VO₂ film as a solid rectangular plate bottom electrode to create an enhanced vertical electric field that can induce a lateral modal vibration via transverse d_{31} piezoelectric coefficient to match well with the desired strain field pattern for the corresponding lateral-extensional mode at 86 MHz.

As opposed to the aforementioned mode-switching behavior, the resonance at 152 MHz shows a drastically different response, where both the signal level and the capacitive feedthrough level are elevated by roughly 15 dB when the VO₂ thin film underneath the Pt slot-divided bottom electrode transitions into its rutile (metallic) phase. Also, the resonance frequency shifts slightly due to the variation of the electric field patterns before and after electrode reconfiguration, which in turn changes the key characteristic dimension.

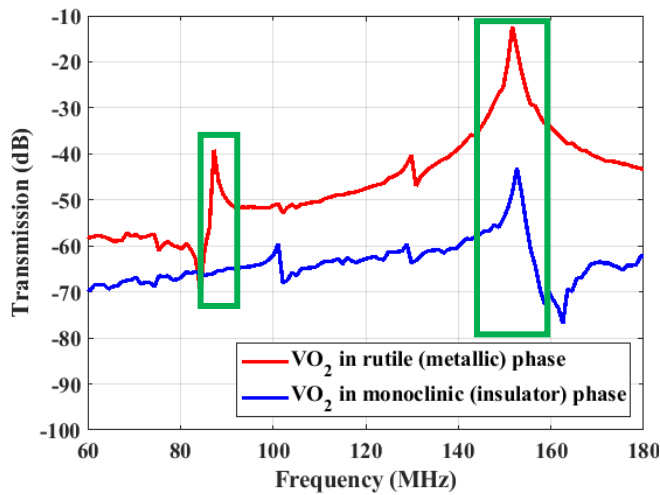


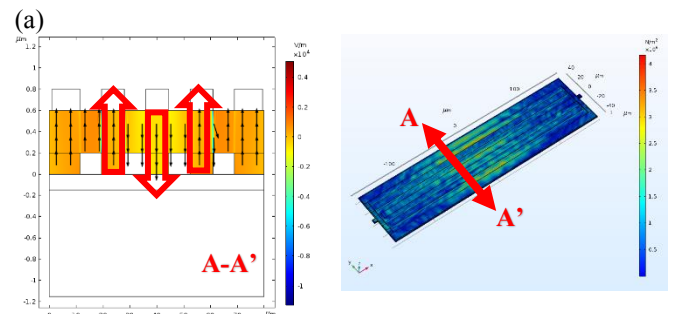
Fig. 3. The frequency response of two-port ZnO MEMS resonator with a reconfigurable bottom electrode growing on thin-film VO₂ by finite element analysis. The conductivity of the thin-film VO₂ in monoclinic or rutile phase impacts the resonance frequency and capacitive feedthrough level.

Fig. 4 presents the electric fields in two-dimension (2D) cross sectional view and the corresponding piezoelectrically-induced stress patterns in three-dimension (3D) schematic view by the reconfigurable bottom electrode, which is enabled by the phase transition of the thin-film VO₂. As seen by the FEM simulation, the electric field, displacement, and stress are confined between the interdigitated top electrodes and the reconfigurable bottom electrode. Due to two targeted resonance frequencies are 3rd and 5th order symmetric width lateral-extensional mode, the distribution and direction of the vertical electric field strength in the ZnO piezoelectric transducer layer and the transverse d_{31} piezoelectric constant determine the strength of the resonance signal of desired resonance mode shape. Thus, the conductivity of thin-film VO₂ during phase transition impacts the bottom electrode geometry and the electric field, modal vibration, and frequency response are also impacted.

Fig. 4 (a) and (b) compare the electric field and stress patterns of a ZnO rectangular-plate, 3rd order symmetrical width lateral-

extensional mode resonator operating at 86 MHz, which are generated by the reconfigurable bottom electrode enabled by the VO₂ thin film in its monoclinic and rutile phase, respectively. As shown, the orientation of the electric field underneath the three central top electrodes is flipped due to the electric field pattern in the ZnO layer is impacted by the slot-divided bottom electrode and the phase transition VO₂ thin film. The abrupt conductivity changes of the thin-film VO₂ during its phase transition from monoclinic to rutile phase to change the bottom electrode shape from slot divided plate to a solid rectangular plate. Moreover, the stress generated within the ZnO resonator body under the rutile phase of the thin-film VO₂ is noticeably stronger than the monoclinic phase. The vertical electric field strength and distribution, the transverse d_{31} piezoelectric coefficient and the piezoelectrically-transduced strain pattern inside the ZnO piezo-transducer layer determines the resonance frequency strength. Thus, the FEM simulated modal resonance responses exhibit a mode-switching behavior for the 86 MHz 3rd order symmetrical width lateral-extensional mode as evidenced by the electric field and the stress patterns.

Meanwhile, Fig. 4 (c) and (d) depict the electric field and stress distributions that are induced by a reconfigurable bottom electrode of a ZnO rectangular-plate 5th order symmetrical width lateral-extensional mode resonator operating at 152 MHz by leveraging the VO₂ thin film in its monoclinic and rutile phase, respectively. As opposed to the resonance mode at 86 MHz, the directions of the electric fields and strain patterns stay largely unchanged before and after phase transition of thin-film VO₂ between monoclinic and rutile phases for reconfiguring the bottom electrode. As a result, the signal strength and capacitive feedthrough level of the 152 MHz resonance mode varies significantly, while the resonance frequency remains at 152 MHz before and after electrode reconfiguration to exhibit a dissimilar behavior apart from mode switching. The anti-resonance frequency at 158 MHz can be clearly observed when VO₂ film is under monoclinic (insulator) phase. Meanwhile, there is no significant anti-resonance frequency when VO₂ film is under rutile (metallic) phase due to the effect of elevated capacitive feedthrough level impacted by the bottom electrode geometrical change during the VO₂ phase transition. The dielectric loss in the resonator is also enhanced as temperature gradually increases. Thus, there is no detectable anti-resonance frequency, when VO₂ film is under rutile (metallic) phase.



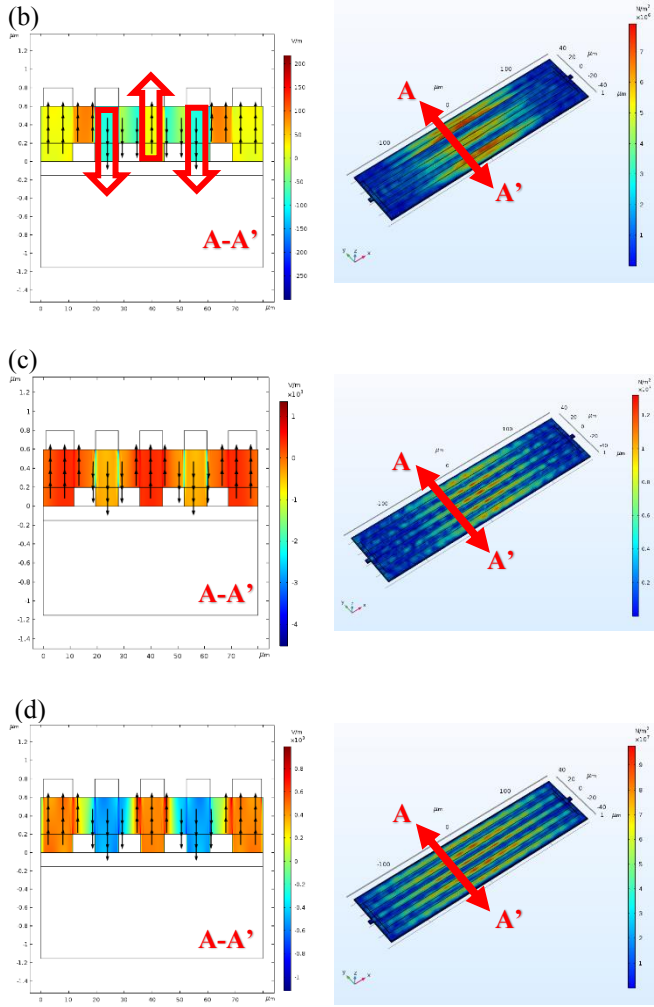


Fig. 4. Finite element analysis results that illustrate electric field change in two-dimensional (2D) and stress in three-dimensional (3D) diagrams due to the abrupt VO₂ conductivity change behavior during phase transition for two different resonance modes, including (a) electric field and stress patterns when VO₂ is under its monoclinic phase for the 86 MHz resonance; (b) electric field and stress patterns when VO₂ is under its rutile phase for the 86 MHz resonance; (c) electric field and stress patterns when VO₂ is under its monoclinic phase for the 152 MHz resonance; (d) electric field and stress patterns when VO₂ is under its rutile phase for the 152 MHz resonance.

IV. FABRICATION PROCESS

The ZnO piezoelectric rectangular-plate, lateral-extensional mode resonators investigated in this work have been fabricated using the cleanroom facility at Nanotechnology Research and Education Center (NREC) of the University of South Florida, while the VO₂ thin films were deposited using pulsed laser deposition (PLD) by the Applied Material Group at the Michigan State University. Fig. 5 illustrates the step-by-step microfabrication process flow starting from a high-resistivity silicon wafer coated with a 1 μm -thick thermal oxide, which is followed by a blanket PLD deposition of a 150 nm-thick VO₂ layer right before deposition and patterning of the platinum (Pt) bottom electrode with a thickness of 200 nm by a lift-off step. The patterned Pt electrode and blanket VO₂ layer act as the bottom electrode of the ZnO piezoelectric transducer. Thereafter, a 550 nm-thick ZnO piezoelectric transducer layer

is deposited by RF sputtering, followed by wet etching of ZnO to create via hole connecting the top and bottom electrodes. The platinum (Pt) top electrodes are deposited and patterned through a lift-off process. Then, a 10 μm -thick AZ-12XT photoresist is patterned as the dry-etching hard mask to define the resonator body. Similar to our prior works [13][42], a dry etch/releasing process that employs an inductively coupled plasma (ICP) etcher is conducted, which begins with reactive ion etching (RIE) of ZnO by CH₄ and Ar reactants, followed by VO₂ RIE etching by SF₆ and Ar reactants [43]. Subsequently, the SiO₂ layer is dry etched by C₄F₈, CH₄, and He gas reactants. Then, the dry releasing process starts with an anisotropic Si etching by a deep reactive ion etching process followed by isotropic dry etching of silicon underneath to fully suspend the resonator.

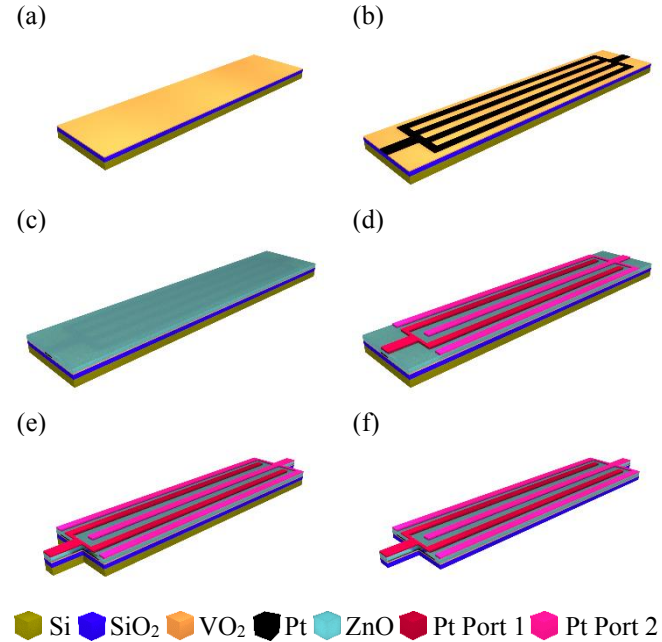


Fig. 5. Step-by-step fabrication process flow of ZnO lateral extensional mode resonators that are equipped with a reconfigurable bottom electrode enabled by the phase transition of the VO₂ thin film.

V. EXPERIMENT RESULTS

The microfabricated devices were measured using a Cascade 12000 RF probe station with a pair of 150 μm pitch ground-signal-ground (GSG) probes from GGB Industries Inc. The two-port scattering parameters (S-parameters) were measured by a Keysight Technology E5071C vector network analyzer, after an open-short-load-thru (OSLT) calibration using a CS-5 calibration standard substrate from GGB Industries Inc. The device temperature was controlled by a built-in thermal chuck during on-wafer probing, and the temperature was measured with a thermocouple along with a U5855A infrared camera from Keysight Technology.

Fig. 6 (a) shows a top-view microscope image of a fabricated two-port 320 $\mu\text{m} \times 80 \mu\text{m}$ rectangular-plate lateral extensional mode resonator that is equipped with five IDT fingers, two side-supporting tethers, and a reconfigurable bottom electrode that

is enabled by the phase transition of VO_2 . All the measurement results are obtained from devices of this exact resonator design configuration with an exception of the bottom electrode shape. The thin-film VO_2 is under monoclinic (insulator) phase and rutile (metallic) phase when operating at 20°C and 95°C , respectively. As shown in Fig. 6 (b), the capacitive feedthrough level of broadband frequency response at 95°C is 6-10 dB higher than that measured at 20°C due to the orders of magnitude higher conductivity of the thin-film VO_2 when it undergoes phase transition from monoclinic to rutile phase. Meanwhile, the insertion loss for the 148 MHz (5th order symmetrical width lateral-extensional mode) resonance is lowered from 43.5 dB to 32.7 dB that can be mainly ascribed to elevated vertical electric field strength that generate stronger lateral modal vibration and modal strain pattern via transverse d_{31} piezoelectric coefficient when the VO_2 thin film of the reconfigurable bottom electrode is under its rutile (metallic) phase to form a solid rectangular plate. As opposed to signal strength enhancement of the 148 MHz resonance, there is a more drastic mode-switching behavior for the resonance at 88 MHz (3rd order symmetrical width lateral-extensional mode) as shown in Fig. 6. In particular, there is no resonance peak at 88MHz when the device operates at 20°C . The thin-film VO_2 is under monoclinic (insulator) phase to cause a mismatch of the bottom electrode pattern in slot divided shape against the target mode shape and lack of desired electric field pattern to excite this resonance mode via transverse d_{31} piezoelectric coefficient. On the contrary, a strong resonance signal appears at 88 MHz when the thin-film VO_2 change to its rutile (metallic) phase, thus reshaping the bottom electrode as a solid rectangular plate to create stronger vertical electric field and in-plane modal strain patterns induced by transverse d_{31} piezoelectric effect for exciting the device into its modal vibration at 88 MHz through ZnO piezoelectric transducer. To the best of our knowledge, this unprecedented mode-switching behavior enabled by VO_2 phase transition and bottom electrode reconfiguration of a ZnO piezoelectric lateral-extensional mode resonator has never been reported previously.

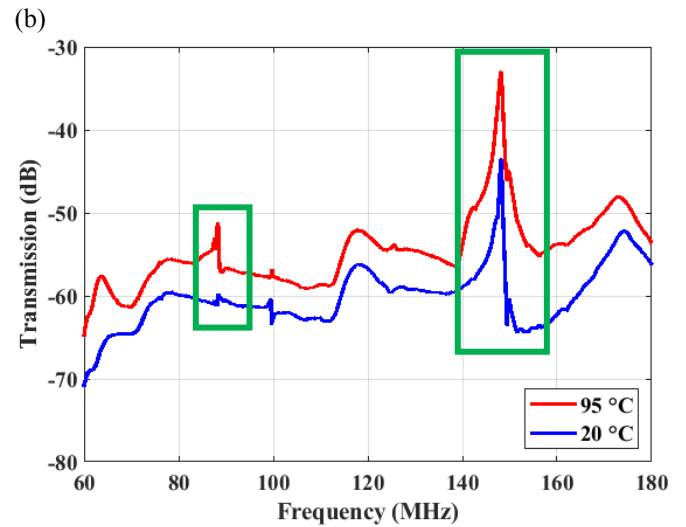
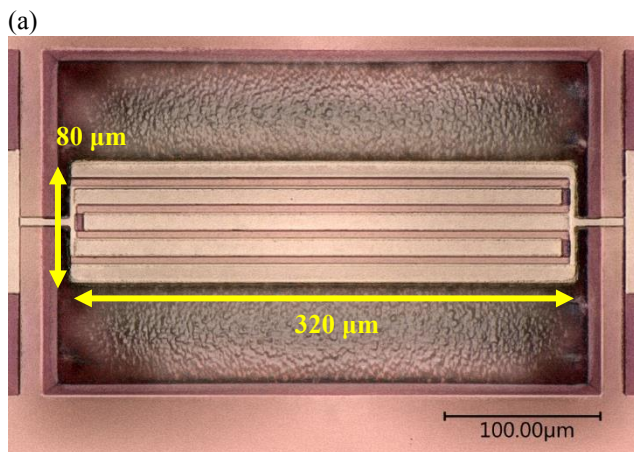


Fig. 6. (a) Top-view microscope image of a fabricated two-port $320\ \mu\text{m} \times 80\ \mu\text{m}$ rectangular-plate lateral extensional mode resonator with five IDT fingers, two side-supporting tethers, and a reconfigurable bottom electrode that is enabled by the phase transition of VO_2 (b) Measured broadband frequency responses of a two-port MEMS resonator that is equipped with a reconfigurable bottom electrode composed of a VO_2 thin film that is embedded below the ZnO piezoelectric transducer layer and the Pt slot-divided rectangular-plate bottom electrode. Both the capacitive feedthrough and the resonance signal levels are elevated when the thin-film VO_2 is transitioned from its monoclinic (insulator) phase (20°C) to rutile (metallic) phase (95°C).

Fig. 7 (a) shows the frequency responses of a two-port ZnO MEMS resonator with embedded thin-film VO_2 underneath slot-divided rectangular-shaped Pt bottom electrode that have been characterized at temperatures between 20°C and 95°C with an increment of 20°C . As shown in Fig. 7 (a), the feedthrough and signal levels of the 148 MHz, which is 5th order symmetrical width lateral-extensional mode, resonance gradually increase along with the temperature increase between 20°C and 60°C , whereas the largest boost of the resonance signal is observed when the thin-film VO_2 completes its phase transition during heating before reaching 95°C . At 95°C , the VO_2 film is under its rutile (metallic) phase thus converting the slotted bottom electrode into a solid rectangular plate, which results in much better aligned vertical electric field, d_{31} piezoelectric constant and piezoelectrically-transduced strain patterns to exhibit a better spatial match with the target 5th order symmetrical width lateral-extensional mode shape at 148 MHz.

Fig. 7 (b) shows frequency responses of a two-port MEMS rectangular-plate, 5th order symmetrical width lateral-extensional mode resonator with VO_2 film embedded under a Pt solid rectangle plate bottom electrode, which are measured at temperatures between 20 and 95°C with an increment of 20°C . For this design, the phase-transition of thin-film VO_2 does not significantly impact the feedthrough and resonance signal levels, because the overlapping solid rectangular plate (slotted-less) electrode made of stacked VO_2 and Pt layers is dominated by the high conductivity of Pt bottom electrode instead of the effects of the VO_2 phase transition.

Fig. 7 (c) shows the 5th order symmetrical width lateral-extensional mode frequency responses of a ZnO only two-port MEMS resonator with the same interdigital top electrodes and

slot-divided rectangular plate bottom electrode identical to the design shown in Fig. 7 (a), which are tested at temperature ranging from 20 to 95°C with an increment of 20°C. As opposed to tested temperature-dependent frequency responses with an embedded VO₂ phase-transition layer underneath the bottom electrode as shown in Fig. 7 (a), the measured frequency characteristics of the ZnO only resonators without VO₂ exhibit no noticeable change of both resonance signal and capacitive feedthrough levels, while exhibiting a linear temperature dependence of the resonance frequency. The measured resonance frequency decreases with rising temperature, showing a linear temperature dependence that can be largely attributed to the temperature dependence of Young's modulus of all structural materials and the lateral geometry expansion due to the temperature increase.

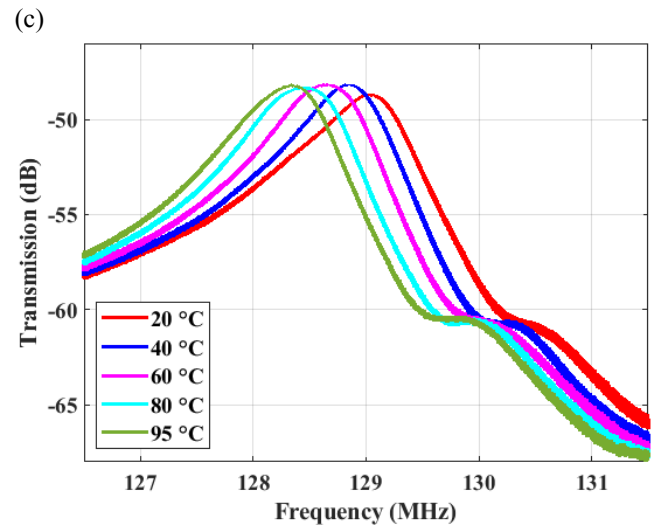
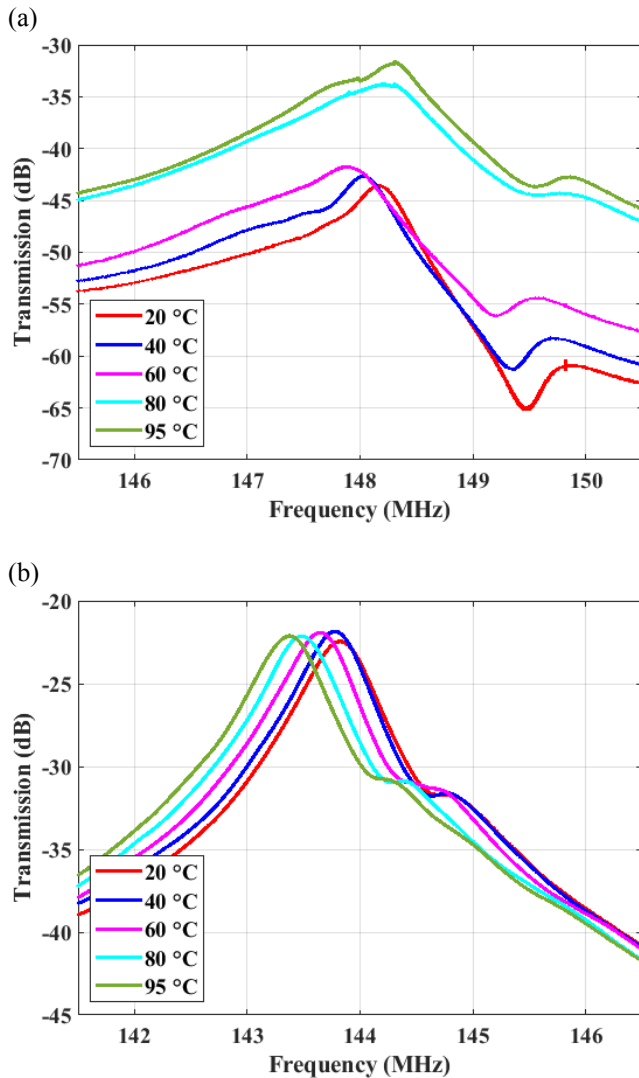


Fig. 7. The frequency responses of a two-port 5th order symmetrical width lateral-extensional mode ZnO only MEMS resonator measured during a heating cycle from 20 to 95°C with a 20°C increment, by showing the tested frequency characteristics of: (a) device with a slotted rectangular plate (reconfigurable) bottom electrode; (b) device with a solid rectangular plate (non-reconfigurable) bottom electrode; and (c) reference device with a Pt slotted rectangular plate bottom electrode but no VO₂ film.

Fig. 8 (a) and (b) show the frequency characteristics for the resonance mode at 88 MHz, 3rd order symmetrical width lateral-extensional mode of a two-port 320 $\mu\text{m} \times 80 \mu\text{m}$ rectangular-plate ZnO resonator with a reconfigurable bottom electrode composed of a VO₂ layer that are tested at temperature ranging from 20°C to 95°C during heating and cooling cycles with an increment of 20°C, respectively. Fig. 8 (c) and (d) show the hysteresis behavior of resonance frequency and insertion loss that are measured during heating and cooling cycles for the full temperature range between 60 to 95°C, respectively. As shown in Fig. 8 (a) and (b), the capacitive feedthrough level rises by 4–5 dB due to the thin-film VO₂ phase transition. To the best of our knowledge, this unique mode-switching behavior of a ZnO piezoelectric resonator by taking advantage of the electric field modification by a phase transition material has never been reported. Fig. 8 (c) shows the mode switch-on behavior of the 88 MHz resonance that starts at 70°C when the device is tested during a heating cycle, whereas the switch-off transition begins at 60°C during the cooling cycle. There is no resonance mode at 88 MHz that can be observed below 70°C when a device is tested under a heating cycle. Similarly, there is no resonance mode below 60°C when a device is tested under a cooling cycle. The resonance frequency increases from 88.17 to 88.43 MHz when the temperature gradually ramps up from 70 to 95°C, while the resonance frequency decreases from 88.41 to 88.1 MHz when the device is cooling down from 95 to 60°C. Meanwhile, Fig. 8 (d) depicts the thermal hysteresis behavior in terms of the insertion loss for the 88 MHz resonance. When the device undergoes a gradual temperature increase from 70 to 95°C, the insertion loss lowers from 55.5 to 49.4 dB, whereas the insertion loss increases from 49.5 to 56.5 dB while the device is cooling down from 95 to 60°C. The insertion loss is heavily dependent on vertical electric field strength to generate an in-plane lateral modal vibration/strain pattern via transverse d₃₁ piezoelectric effect to excite the 88 MHz resonance mode.

These hysteresis behaviors indicate a different critical phase-transition temperature for the VO₂ between the heating and cooling cycles, where a higher phase transition temperature of 8-10°C has been observed during the heating cycle as compared to that of cooling cycle.

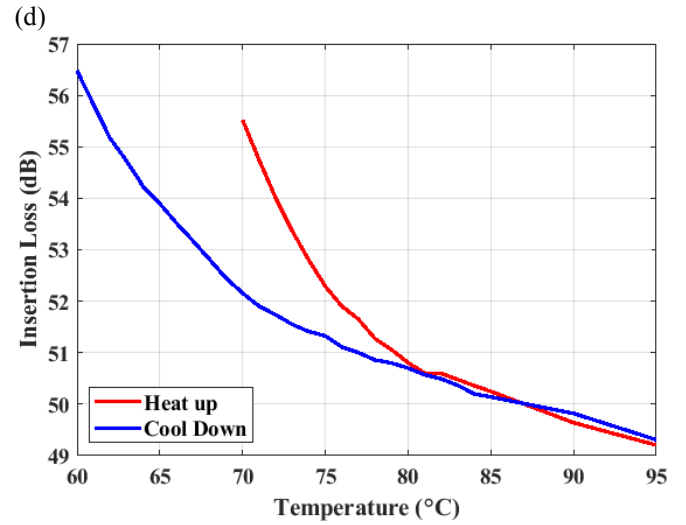
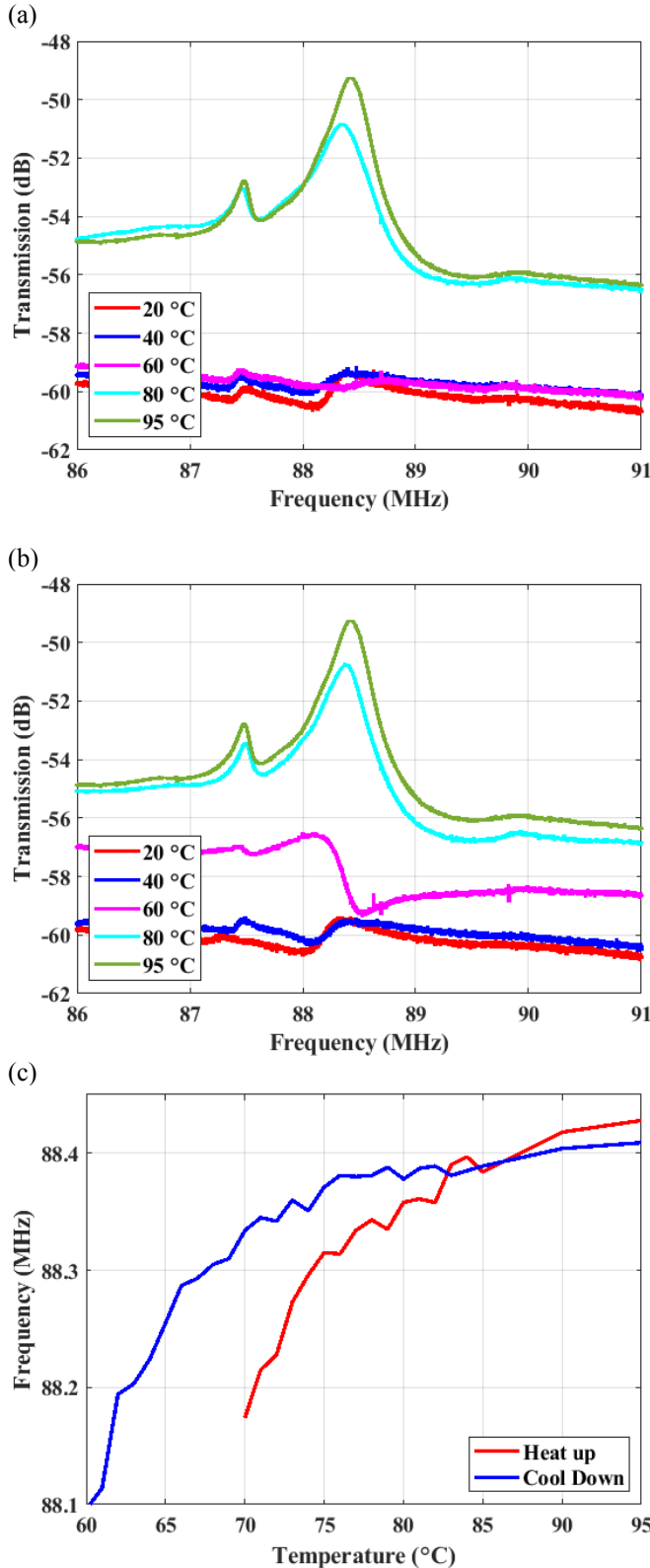


Fig. 8. Measured frequency responses of a two-port ZnO MEMS resonator with a reconfigurable bottom electrode that is composed of a VO₂ thin film underneath the ZnO piezoelectric transducer layer and Pt slotted rectangular plate bottom electrode for the 88 MHz resonance by showing the broadband frequency characteristics measured during (a) a heating cycle at temperature between 20°C and 95°C with a temperature increment of 20°C, (b) a cooling cycle at temperature between 20°C and 95°C with a temperature increment of 20°C. The thermal hysteresis loops across the temperature range of 60-95°C are also shown for both (c) resonance frequency, and (d) insertion loss.

Fig. 9 (a) and (b) show the measured frequency responses for the resonance mode at 148 MHz of the two-port rectangular-plate, 5th order symmetrical width lateral-extensional mode resonator with a reconfigurable bottom electrode composed of a VO₂ layer that are measured at temperature between 20°C and 95°C during heating and cooling cycles with an increment of 20°C, respectively. Fig. 9 (c) and (d) show the hysteresis behavior of resonance frequency and insertion loss that are measured during heating and cooling cycles for the temperature range between 20°C and 95°C, respectively. As shown in Fig. 9 (a) and (b), the capacitive feedthrough and resonance signal levels both increase during the phase transition of the VO₂ thin film from its monoclinic to rutile phase that transforms the shape of the bottom electrode to strengthen the electric fields and spatially match the desired mode shape, thus exciting the 148MHz lateral extension mode. Fig. 9 (c) and (d) show the measured thermal hysteresis loops of resonance frequency and insertion loss for heating and cooling cycles of the 148 MHz resonance for the temperatures between 20°C and 95°C. As shown in Fig. 9 (c), the resonance frequency increases from 148.16 MHz to 147.88 MHz, when the device undergoes a gradual temperature increase from 20°C to 60°C, which can be ascribed to temperature dependence of Young's modulus of all the constituent structural materials as the primary effect below the VO₂ transition temperature. The resonance frequency begins to shift higher from 147.88 to 148.3 MHz at a temperature between 60°C and 95°C, because the VO₂ layer's phase transition fully transforms the shape of the bottom electrode and the electric field pattern for modal excitation of piezoelectric resonator with a changed characteristic modal dimension. As evidenced by the FEM simulation and equivalent circuit model, electrode reconfiguration plays a major role in determining the temperature coefficient of resonance frequency at temperatures above VO₂ phase transition. Meanwhile, the

resonance frequency shift during temperature cycling also depends on the nonlinear variation of the Young's modulus of the VO₂ thin film due to the temperature change during phase transition [44] and conductivity variation of the slot-divided rectangular-plate (reconfigurable) bottom electrode that gradually increases due to the VO₂ thin film phase transition from monoclinic insulator phase and rutile (metallic) phase. Similarly, the resonance frequency of this lateral extension mode shifts lower from 148.3 to 147.94 MHz during the gradual phase transition of the thin-film VO₂ from rutile to monoclinic phase, while the device is cooling down from 95 to 50°C. Then, the resonance frequency rises from 147.94 to 148.15 MHz to exhibit a reverse temperature dependence, when it continues to cool down from 50 to 20°C. As seen in Fig. 9 (d), the insertion loss lowers from 43.5 dB to 31.5 dB during the heating cycle from 20 to 95°C, whereas the insertion loss increases from 31.6 to 43.5 dB during the cooling down from 95 to 20°C. The hysteresis loops of resonance frequency and insertion loss both indicate a 5-10°C discrepancy between the critical phase transition temperatures of the cooling and heating cycles.

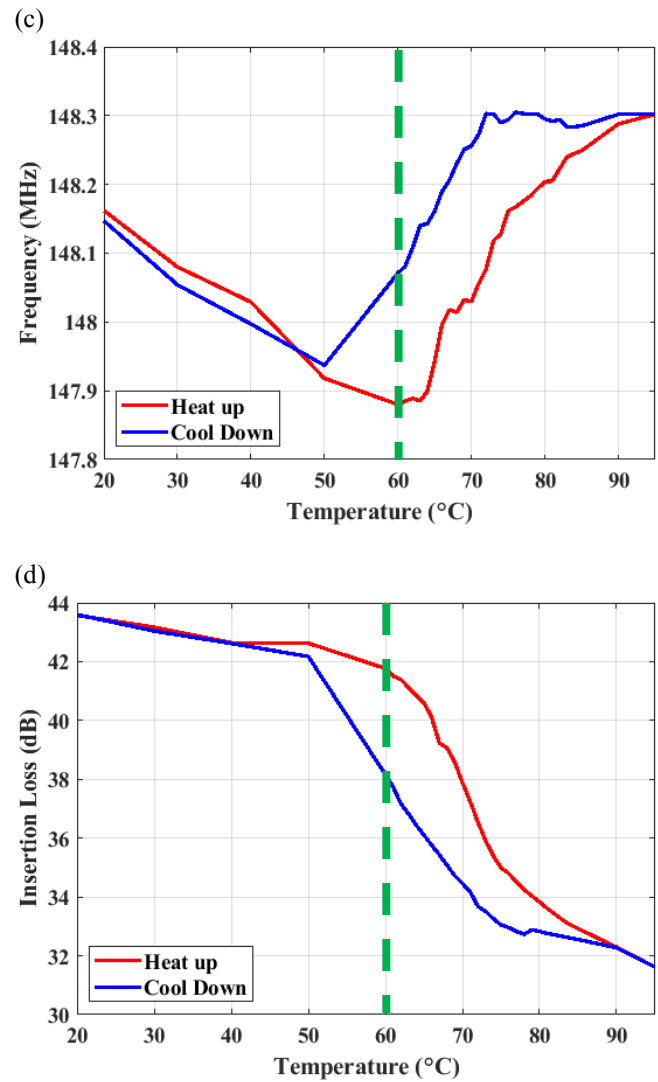
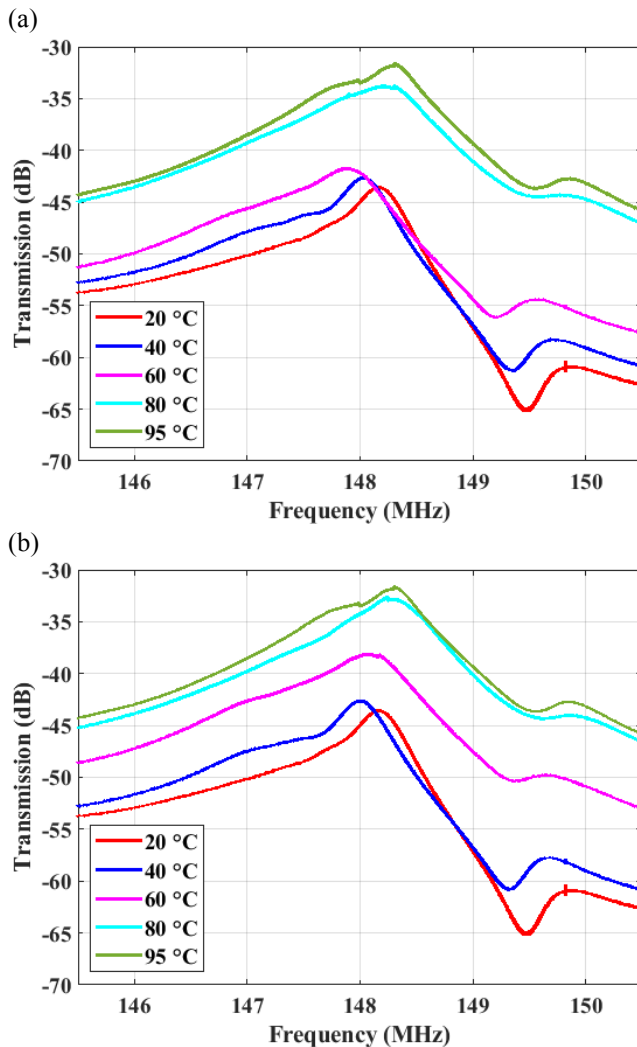


Fig. 9. The frequency responses of the two-port ZnO MEMS resonator with a reconfigurable bottom electrode composed of a VO₂ thin film underneath the ZnO piezoelectric transducer layer and slotted rectangular plate Pt bottom electrode for the 148 MHz resonance by showing the broadband frequency characteristics measured during (a) a heating cycle at temperature between 20 and 95°C with a temperature increment of 20°C, (b) a cooling cycle at temperature between 20 and 95°C with a temperature increment of 20°C. The thermal hysteresis loops across the temperature range of 20-95°C are also shown for both (c) resonance frequency, and (d) insertion loss.

VI. DISCUSSION

Fig. 10 presents a conceptual illustration diagram and the corresponding equivalent circuit model for the two-port piezoelectric resonator, where the VO₂ film underneath the piezoelectric transducer layer and the slot-divided rectangular Pt bottom electrode is under monoclinic and rutile phase, respectively. As depicted in Fig. 10, the full equivalent circuit model with varied static capacitance (C_0) induced by the reconfigurable bottom electrode is employed to analyze modal resonances at 148 MHz (5th order symmetrical width lateral-extensional mode) as example at 20°C and 95°C, which the VO₂ films are in monoclinic and rutile phase, respectively.

Fig. 10 (a) shows the simulated and measured frequency responses based on measurement and equivalent circuit for the device at 20°C (VO₂ in monoclinic phase), while operating at 5th order lateral width extensional mode. Fig. 10 (b) shows the frequency responses based on measurement and equivalent circuit model for the device at 95°C (VO₂ in rutile phase), while operating at 5th lateral width-extensional mode. There is a spurious mode at ~149 MHz adjacent to 5th lateral-extensional mode at 148 MHz. In order to model these two resonances of similar resonance frequencies, two shunt RLC equivalent circuits are employed to capture their resonance responses. The R_m , L_m and C_m are used to simulate the 5th order lateral-extensional mode and R'_m , L'_m and C'_m are included to simulate the frequency response of that spurious mode. The cross-field capacitance (C_0) when device is operating at 20°C under its monoclinic phase is created by C_{Pt} , which is the capacitance between IDT top electrodes and slot-divided bottom electrode. C_{Pt} is 9.3 fF in the equivalent circuit model. The values for R_m , L_m and C_m for 5th order symmetrical lateral width-extensional mode and the R'_m , L'_m and C'_m at 95°C for the spurious mode are listed in Table 1 below. When the resonator is heated up to 95°C, the VO₂ film changes its phase from monoclinic (isolator) phase to rutile (metallic) phase. Due to the VO₂'s phase transition to become conductive, the bottom electrode shape is converted to a solid rectangular plate from the originally designed slot-divided rectangular electrode. The cross-field capacitance (C_0) at 95°C include both C_{Pt} and C_{VO2} , which is capacitance between conductive VO₂ film and top electrodes. C_{VO2} is determined to be 10.5 fF that is comparably higher than 9.3 fF when VO₂ is under monoclinic phase largely due to enlarged bottom electrode from slot divided to solid rectangular plate during VO₂'s phase transition. And the C_{VO2} is parallel to the C_{Pt} . Thus, the cross-field capacitance (C_0) when device at 95°C is ascribed to a combined effect of both C_{Pt} and C_{VO2} , which is 19.8 fF. The values for R_m , L_m and C_m for 5th order symmetrical lateral-extensional mode and the R'_m , L'_m and C'_m at 95°C for spurious mode are shown in Table 1 below.

Table 1. The parameters of the equivalent circuit model extracted from the measurement data when the device at 20°C and 95°C

Temp. (°C)	Cross-field capacitance (C_0)		5 th order symmetrical lateral width extensional mode			Spurious mode		
	C_{Pt} (fF)	C_{VO2} (fF)	R_m (Ω)	L_m (μH)	C_m (fF)	R'_m (Ω)	L'_m (μH)	C'_m (fF)
20	9.3	-	3,900.5	1,050.0	1.1	3,600.5	898.0	1.3
95	9.3	10.5	1,310.5	281.1	4.1	440.5	100.4	11.3

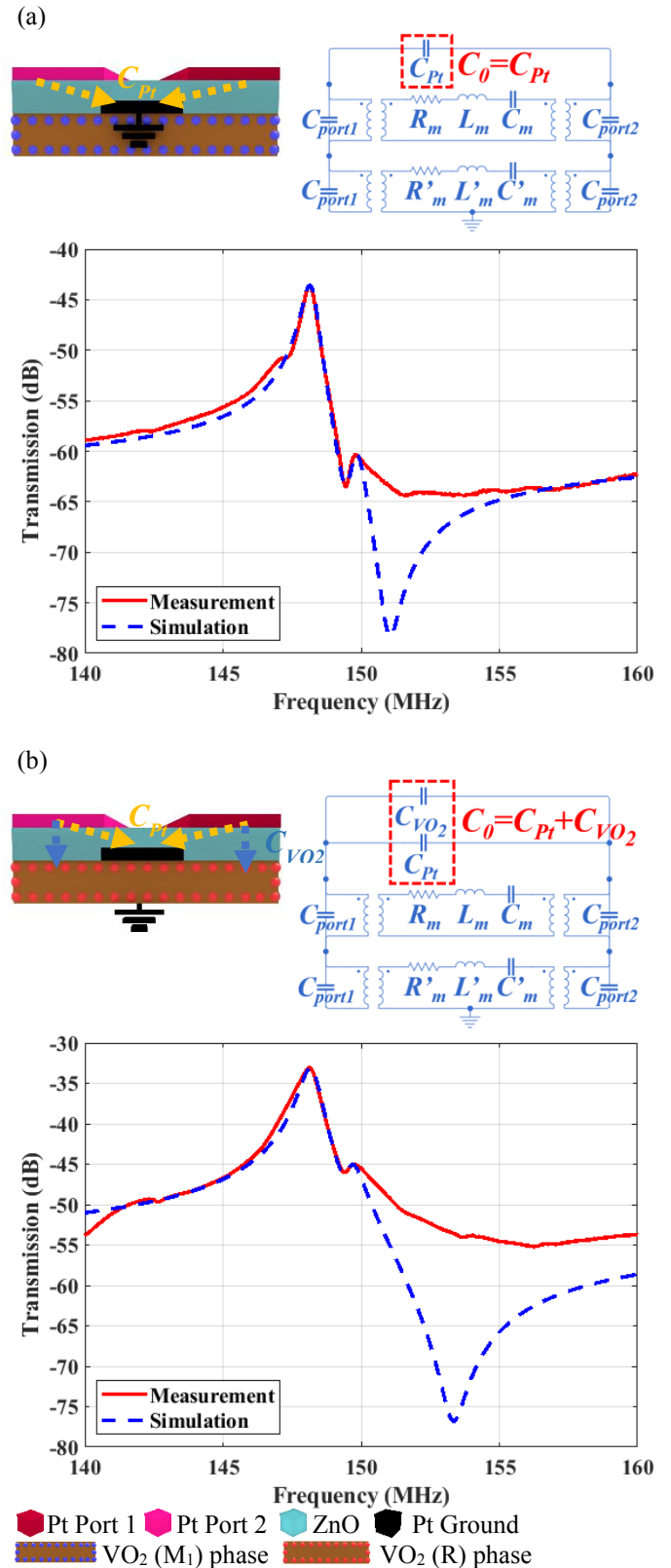


Fig. 10. A conceptual illustration diagram for modeling the capacitive feedthrough level in a two-port 5th order symmetrical width lateral-extensional mode piezoelectric resonator and equivalent static capacitance (C_0) in a corresponding equivalent circuit model, where the VO₂ layer is under (a) monoclinic phase, and (b) rutile phase.

Fig. 11 (a) shows the temperature coefficient of frequency (TCF) of a two-port ZnO MEMS resonator with embedded thin-film VO₂ underneath a slot-divided, rectangular-plate Pt bottom electrode that are characterized at 5th order symmetrical width lateral-extensional mode at temperature between 20°C and 95°C with an increment of 10°C. As shown in Fig. 11 (a), the resonance frequency shows a linear dependence during both heating and cooling cycles when VO₂ film is under monoclinic insulator phase. The extracted TCF is -48.93 ppm/°C when the device undergoes a gradual temperature increase from 20°C to 60°C during a heating cycle, whereas a TCF of -46.35 ppm/°C is observed when it is cooling down from 50°C to 20°C.

Fig. 11 (b) presents the measured 5th order symmetrical width lateral-extensional mode resonance frequency over a temperature range between 20°C and 95°C with an increment of 10°C and the extracted TCF values of a two-port ZnO MEMS resonator with VO₂ thin-film embedded under a solid rectangle plate Pt bottom electrode. As shown in Fig. 11 (b), the TCF of this device is -45.22 ppm/°C when the device undergoes a gradual temperature increase from 20°C to 95°C during heating cycle, whereas a TCF of -46.98 ppm/°C is obtained when the device is gradually cooling down from 95°C to 20°C. Under heating and cooling cycles, the resonance frequency exhibits a linear dependence upon the temperature change for this design a solid rectangular-plate (slotted-less) bottom electrode made of stacked VO₂ and Pt layers. Consequently, the phase transition of the VO₂ layer that directly overlaps with a highly conductive Pt electrode makes little impacts on the bottom electrode shape. It is worthwhile mentioning that the rectangular plate resonator design with a solid rectangular plate Pt bottom electrode and an embedded VO₂ layer retains all design parameters identical to those of the slot-divided design. Obviously, these two resonator designs that are both equipped with an identical layer stack and geometrical parameters of the resonator body and top electrodes have exhibited very different temperature dependence of resonance frequency over the temperature range between 20 and 95°C. Therefore, the phase-transition dependent nonlinear TCF behavior can no longer be mainly ascribed to temperature dependence of the Young's modulus of all the stacked resonator structural layers including VO₂, the abrupt change of electrical field and piezoelectrically-induced stress patterns before and after the bottom electrode reconfiguration is anticipated to play a dominant role in leading to nonlinear temperature dependence especially at temperatures above the IMT transition of VO₂.

Fig. 11 (c) shows the TCF of a ZnO only MEMS resonator at 5th order symmetrical lateral-extensional mode with the same interdigital top electrodes and slotted rectangular plate bottom electrode identical to the design with embedded VO₂ as shown in Fig. 11 (a), which are measured at temperature ranging from 20 to 95°C with an increment of 10°C. To act as a reference device without a built-in VO₂ phase-transition layer underneath bottom electrode, the TCF of the ZnO only resonators without the VO₂ layer is -70.28 ppm/°C when the device undergoes a gradual temperature increase from 20 to 95°C, while a similar TCF of -64.70 ppm/°C is observed when the device is gradually cooling down from 95 to 20°C. The measured TCF in Fig. 11

(a) and (c) are quite different, which suggests the embedded VO₂ layer instead of the slot-divided bottom electrode design strongly impacts resonance frequency and its temperature dependence during the heating and cooling cycle. Meanwhile, Fig. 11 (a) and (b) shows similar linear TCF behaviors of comparable TCF values, as these two designs have different bottom electrode geometry and the resonator body layer stack constitution. As the VO₂ film embedded underneath the original Pt bottom electrode acts as an insulation layer under monoclinic phase and Pt has superior conductivity as compared to that of VO₂ under its rutile (metallic) phase, it is anticipated for the design with solid rectangular plate Pt bottom electrode to exhibit no noticeable change in its frequency response such as mode switching or resonance signal level boosting, when it undergoes a temperature variation between 20 and 95°C. On the contrary, the effects of thin-film VO₂ phase transition on the resonance signal characteristics are clearly observed in design with slot-divided bottom electrode that enables reconfiguration of the bottom electrode in terms of its geometry as can be seen in Fig. 7, 8, 9, and 11. At the same time, the measured TCF is slightly lowered due to the incorporation of VO₂ layer that is evidenced when comparing results shown in Fig. 11 (b) and (c), which can be attributed to the Young's modulus temperature dependence of the VO₂ thin film similar to prior works [44]. As shown in Fig. 11(a), the VO₂ thin film starts its phase transition from monoclinic (insulator) phase to rutile (metallic) phase after reaching 60°C during a heating cycle. The resonance frequency shifts from 147.88 to 148.3MHz, when the temperature rises from 60 and 95°C due to thin-film VO₂ phase transition, which completely transforms the shape of the bottom electrode and the electric field pattern for spatially matched mode excitation of the 148MHz lateral extensional mode and modification of the effective static capacitance represented by C_0 in the equivalent circuit model. The V-shape resonance frequency dependence upon the temperature is a combined effect of a changed characteristic dimension and total static capacitance due to the electrode reconfiguration, Young's modulus temperature dependence of the VO₂ thin film during its phase transition, and conductivity variation of the slot-divided rectangular-plate (reconfigurable) bottom electrode that gradually increases due to the VO₂ thin film phase transition from monoclinic (insulator) phase and rutile (metallic) phase. A great deal of resonator design and fabrication process change is required in order to isolate the contributions of the effects of the electrode or electric field reconfiguration and temperature dependence of the Young's modulus of the VO₂ thin film, which is beyond the scope of this work.

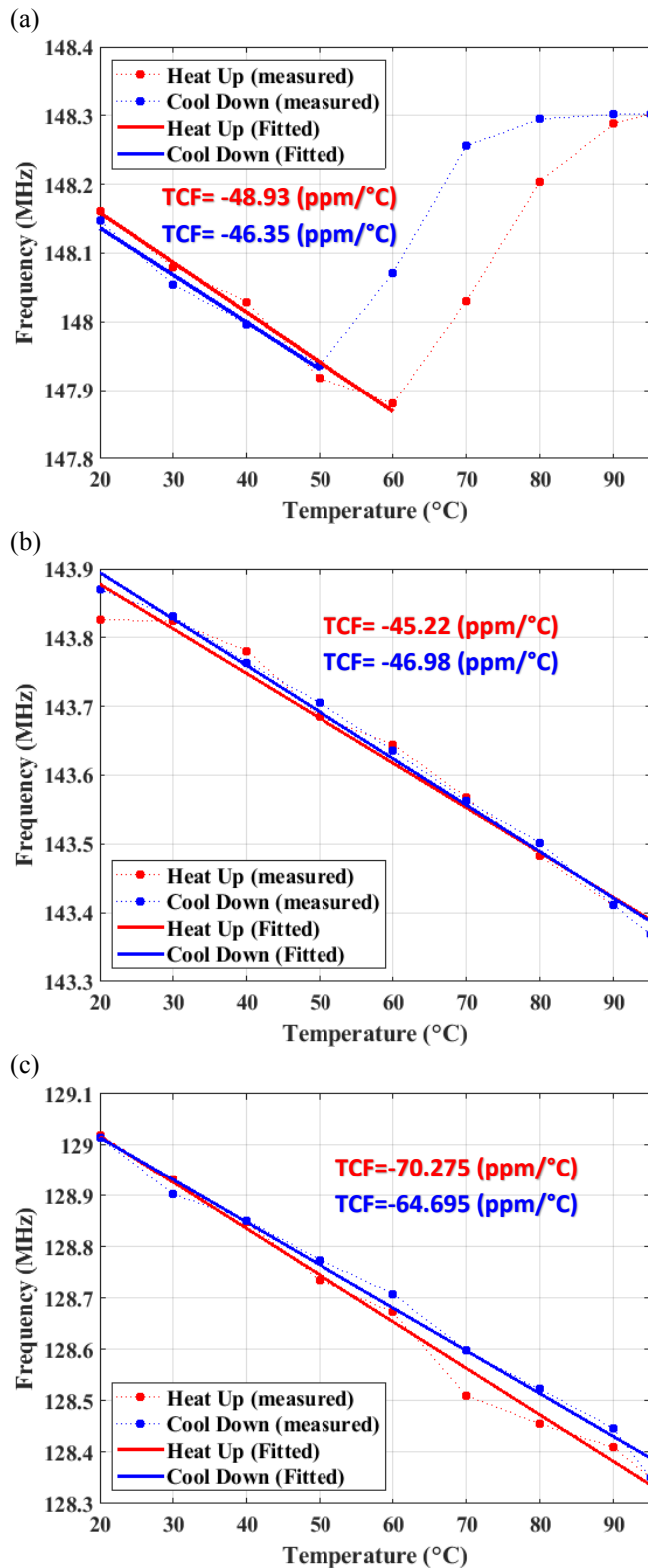


Fig. 11. The temperature coefficient of frequency (TCF) of the two-port ZnO MEMS resonator during a heating and cooling cycle from 20°C and 95°C with a 10°C increment, by showing the frequency characteristics of (a) a design with a slot-divided rectangular-plate (reconfigurable) bottom electrode, (b) a design with a solid rectangular plate (non-reconfigurable) bottom electrode, and (c) a ZnO only reference design with a slot-divided rectangular plate bottom electrode that is not equipped with a VO₂ thin film.

VII. CONCLUSION

This paper presents a two-port rectangular-plate, lateral-extensional mode ZnO piezoelectric resonator with a reconfigurable bottom electrode by embedding a vanadium dioxide (VO₂) thin film as a phase transition material. As a result of the temperature variation, the phase transition of the VO₂ thin film buried underneath the slot-divided Pt electrode transforms the geometry of the bottom electrode, therefore dramatically varying the electric field distribution and piezoelectrically-transduced strain patterns. Consequently, a unique and unprecedented resonance mode-switch behavior enabled by VO₂ phase transition has been observed for the first time. FEM analysis was employed to model the broadband frequency responses and significant change of the electric field and strain field patterns before and after the reconfiguration of bottom electrode's geometry was observed. In order to characterize the temperature dependence, frequency responses of a two-port resonator have been measured over a temperature range between 20 and 95°C while focusing on two specific resonances at 88 and 148 MHz. Both the feedthrough and resonance signal levels have shown a strong dependence on the hysteretic behavior of VO₂ thin film during a heating or cooling cycle. The unique mode switch-on behavior of the 88 MHz resonance starts at 70°C during a heating cycle and switch-off transition begins at 60°C during a cooling cycle due to the abrupt electric field modification by reconfigurable bottom electrode. Moreover, a decrease of the insertion loss and resonance frequency of 12 dB and 0.28 MHz, respectively, have been observed for the 148 MHz resonance in response to a temperature increase from 20 to 60°C that is below the phase transition temperature. This suggests that the temperature dependence of Young's modulus of all constituent structural materials including VO₂ play a dominant role below the transition temperature. Meanwhile, a resonance frequency increase of 0.42 MHz was observed during a further temperature increase from 60 to 95°C that can be ascribed to combined effects of static capacitance increase due to bottom electrode reconfiguration, Young's modulus temperature dependence of VO₂ during its phase transition, and better piezoelectrically-transduced strain field to mode shape match when the bottom electrode is converted from a slot-divided plate into a solid rectangular plate geometry. The equivalent circuit model also confirms a capacitive feedthrough level increase and resonance frequency shift when VO₂ is transitioned from monoclinic (insulator) to rutile (metallic) phase. Three resonator designs with identical top IDT electrodes have been jointly investigated, including two devices with VO₂ embedded underneath a slot-divided rectangular plate and a solid rectangular plate bottom electrode, respectively, as well as one design with a slot-divided rectangular plate bottom electrode but no VO₂. As indicated by the measured temperature coefficient of resonance frequency (TCF), both the bottom electrode reconfiguration and VO₂ phase transition influence the resonance frequency responses that exhibit a nonlinear dependence upon the temperature variation across the temperature range between 60°C and 95°C.

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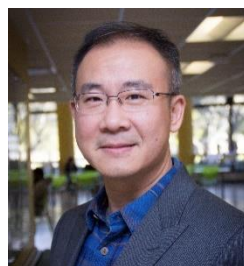
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